

## Chip beads

## For general signal line

## High GHz noise countermeasure (high-speed signal line)

## MMZ-V series



## MMZ1005-V type



## FEATURES

- 1005 size noise reduction solution for general signal lines.
- Compared to the MMZ-E series, it can attain high impedance at GHz bands.
- Exerts an excellent noise reduction effect against noise interfering at several GHz such as LTE or Wi-Fi, or against high-frequency noise.
- Achieves particularly high impedances in the range from 0.7GHz to 3GHz, enabling a reduction of noise that could not be reduced using the conventional MMZ-E series.
- Realizes the highest impedance in the industry at 2.5 GHz through the adoption of a newly-developed material. (2013年8月TDK調べ)
- Operating temperature range: -55 to +125°C

## APPLICATION

- Ensuring communication sensitivity of wireless communication using high-speed signals such as LTE or Wi-Fi
- Noise removal for mobile devices such as smartphones and tablet terminals, and various modules.
- Noise removal for PCs and recorders, household appliances such as STBs, smart grids, and industrial equipment.

## PART NUMBER CONSTRUCTION

MMZ	1005	AFZ	750	V	T	000
Series name	LxWxT dimensions 1.0x0.5x0.5 mm	Material name	Impedance ( $\Omega$ ) at 100MHz	Characteristic type	Packaging style	Internal code

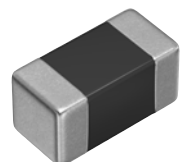
## CHARACTERISTICS SPECIFICATION TABLE

Impedance [100MHz]		[1GHz]		[2.5GHz]		DC resistance	Rated current	Part No.
( $\Omega$ )	Tolerance	( $\Omega$ )	Tolerance	( $\Omega$ )		( $\Omega$ )max.	(mA)max.	
75	±25%	500	±40%	1400		0.90	250	<a href="#">MMZ1005AFZ750VT000</a>
150	±25%	1000	±40%	2500		1.30	200	<a href="#">MMZ1005AFZ151VT000</a>
180	±25%	1200	±40%	3000		1.60	150	<a href="#">MMZ1005AFZ181VT000</a>

## Measurement equipment

Measurement item	Product No.	Manufacturer
Impedance	E4991A+16192A	Keysight Technologies
DC resistance	Type-7556	Yokogawa

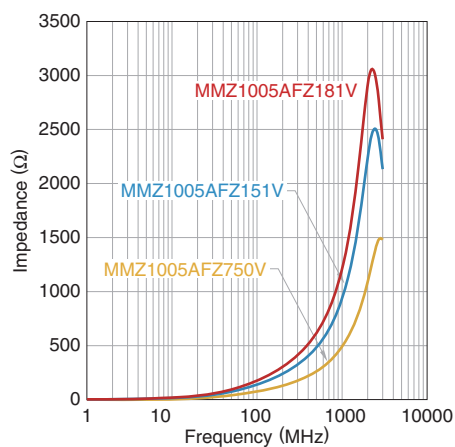
\* Equivalent measurement equipment may be used.



# MMZ1005-V type

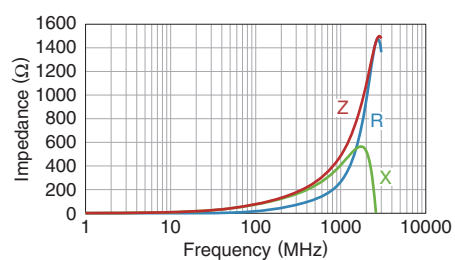
## Z VS. FREQUENCY CHARACTERISTICS (BY SERIES)

### MMZ1005-V series

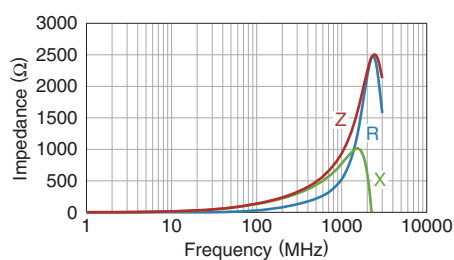


## Z, X, R VS. FREQUENCY CHARACTERISTICS

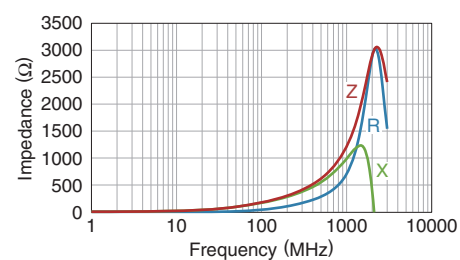
### MMZ1005AFZ750VT000



### MMZ1005AFZ151VT000



### MMZ1005AFZ181VT000



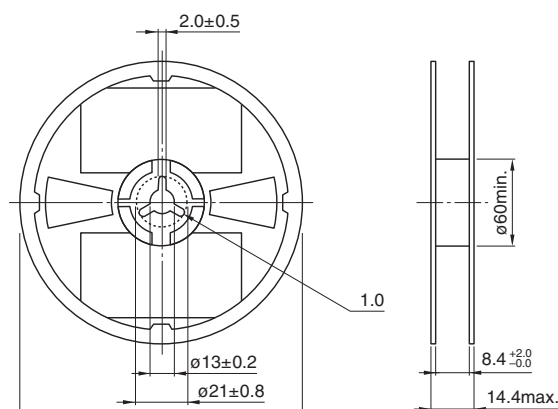
## ■ SHAPE & DIMENSIONS



Dimensions in mm

The graph illustrates the temperature profile over time for a heat treatment process. The y-axis represents Temperature and the x-axis represents Time. The process consists of three main stages: Preheating, Soldering, and Natural cooling. The Preheating stage starts at 150°C and rises to 180°C, with a duration of 60 to 120s. The Soldering stage starts at 180°C and rises to a peak of 250 to 260°C, with a duration of 30 to 60s. The peak temperature is maintained for 10s. The Natural cooling stage follows the peak, with the temperature falling from 230°C.

## REEL DIMENSIONS



Dimensions in mm

[illegible]

Dimensions in mm

Figure 1 illustrates the experimental setup. It shows a horizontal timeline with segments labeled 160min., Taping, 200min., and 300min. Below the timeline, a series of rectangular blocks are depicted, representing the drawing process. An arrow at the bottom indicates the 'Drawing direction' from left to right.

Dimensions in mm

Package quantity	10,000 pcs/reel
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Operating temperature range	Storage temperature range*	Individual weight
-55 to +125°C	-55 to +125°C	1 mg

\* The storage temperature range is for after the assembly.

## REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

### SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

#### REMINDERS

- The storage period is within 12 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH or less).  
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.  
The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.  
If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.  
A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.  
The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.  
If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.

- (1) Aerospace/aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.